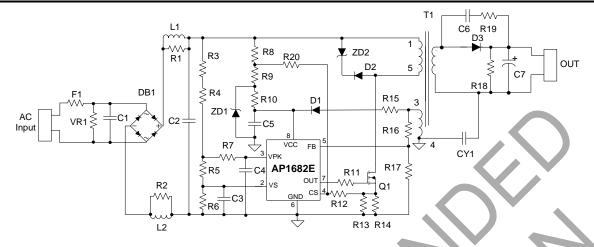


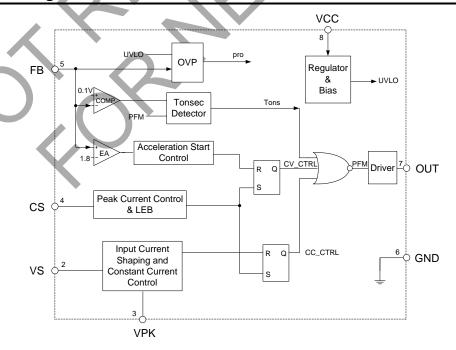
Typical Applications Circuit



Pin Descriptions

Pin Number	Pin Name	Function
1	NC	No connection
2	VS	The rectified input voltage sensing pin. The pin is detecting the instantaneous rectified sine waveform of input voltage
3	VPK	The rectified input voltage peak value sensing pin. The pin is detecting the rectified sine waveform peak value of input voltage
4	CS	Primary current sensing
5	FB	This pin captures the feedback voltage from the auxiliary winding. FB voltage is used to control no load output voltage and determine acceleration stop point at start-up phase
6	GND	Ground. Current return for gate driver and control circuits of the IC
7	OUT	Gate driver output
8	VCC	Supply voltage of gate driver and control circuits of the IC

Functional Block Diagram





Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
Vcc	Power Supply Voltage	-0.3 to +35	V
Іоит	Driver Output Current	300	mA
Vvs, Vpk, Vcs	Voltage at VS, VPK, CS	-0.3 to 7	V
V _{FB}	FB Input Voltage	-40 to 10	V
TJ	Operating Junction Temperature	+150	°C
Тѕтс	Storage Temperature	-65 to +150	°C
TLEAD	Lead Temperature (Soldering, 10s)	+300	°C
PD	Power Dissipation (T _A = +50°C)	0.65	W
ALθ	Thermal Resistance (Junction to Ambient)	190	°C/W
_	ESD (Machine Model)	200	V
_	ESD (Human Body Model)	3000	V

Note 4: Stresses greater than those listed under "Absolute Maximum Ratings" can cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods can affect device reliability.

Recommended Operating Conditions

Symbol	Parameter	Min	Max	Unit
Vcc	Power Supply Voltage	9	21	V
TA	Ambient Temperature	-40	+105	°C

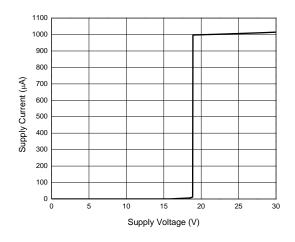


Symbol	Parameter	Conditions	Min	Тур	Max	Unit	
UVLO Section							
V _{TH} (ST)	Start-up Threshold	_	18	19	20	V	
Vopr (Min)	Minimal Operating Voltage	After turn on	7.5	8	8.5	V	
Vcc_ovp	VCC OVP Voltage	_	28	32	34	V	
Standby Current Section							
Ist	Start-up Current	Vcc = V _{TH} (ST)-0.5V, Before start up	-		20	μΑ	
Icc (Max)	Maximum Operating Current	Vvs = Vpk = 3V	4	1000	1300	μΑ	
Drive Output Section						7	
Voн	Output High Level Voltage	IGD-SOURCE = 20mA V _{CC} = 12V	10			V	
VoL	Output Low Level Voltage	IGD-SINK = 20mA VCC = 12V	-		1	V	
t _R	Output Voltage Rise Time	C _L = 1nF	100	140	190	ns	
tF	Output Voltage Fall Time	C _L = 1nF	30	60	90	ns	
Vo-clamp	Output Clamp Voltage	IGD-SOURCE = 5mA Vcc = 20V	12	13.5	15	V	
Vuvlo	UVLO Saturation Voltage	Vcc = 0 to Vcc -on IsinK = 10mA	_	_	1.1	V	
VS Input Section							
V _{VS} /V _{PK} (Max)	Maximum Ratio	$V_{VS} = V_{PK} = 3V$	0.8	1	1.2	V	
Vvs/Vpk (Min)	Minimum Ratio	Vvs = 0V, Vpk = 3V	_	_	0.2	V	
Current Sense Section							
t _{ON} (Min)	Minimum On Time	_	500	750	1000	ns	
Vsocp	Short Circuit Protection Voltage	_	3	4	_	V	
Feedback Input Section							
IFB	FB Pin Input Leakage Current	V _{FB} = 4V	_	2	8	μΑ	
V _{FB} (ACC)	Acceleration Start Threshold	_	1.4	1.8	2.2	V	
V _{FB} (CV)	CV Threshold	_	3.8	4.1	4.4	V	
V _{FB} (OVP)	Over Voltage Protection	_	5.6	6.25	6.9	V	
Over Temperature Protection Section							
_	Shutdown Temperature	_	_	+140	_	°C	
_	Temperature Hysteresis	_	_	+20	_	°C	

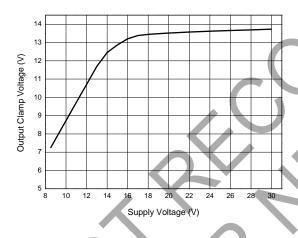


Performance Characteristics

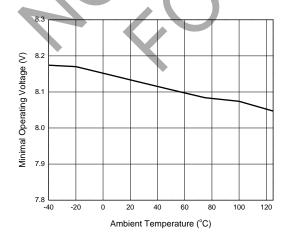
Supply Current vs. Supply Voltage



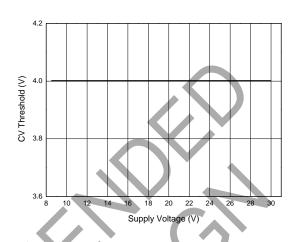
Output Clamp Voltage vs. Supply Voltage



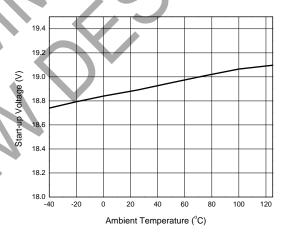
Minimal Operating Voltage vs. Ambient Temperature



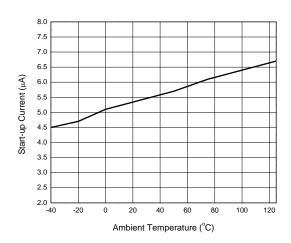
CV Threshold vs. Supply Voltage



Start-up Voltage vs. Ambient Temperature



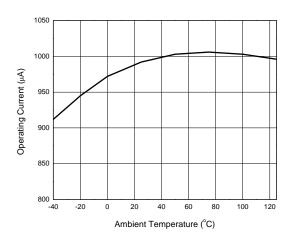
Start-up Current vs. Ambient Temperature



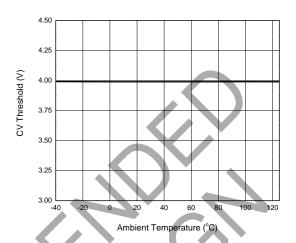


Performance Characteristics (continued)

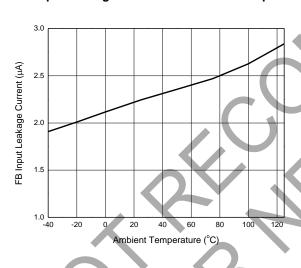
Operating Current vs. Ambient Temperature



CV Threshold vs. Ambient Temperature

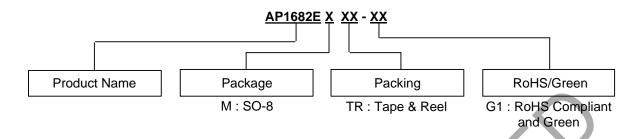


FB Input Leakage Current vs. Ambient Temperature



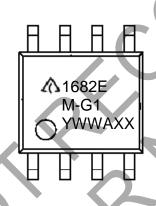


Ordering Information



Package	Temperature Range	Part Number	Marking ID	Packing
SO-8	-40°C to +105°C	AP1682EMTR-G1	1682EM-G1	4000/13"Tape & Reel

Marking Information



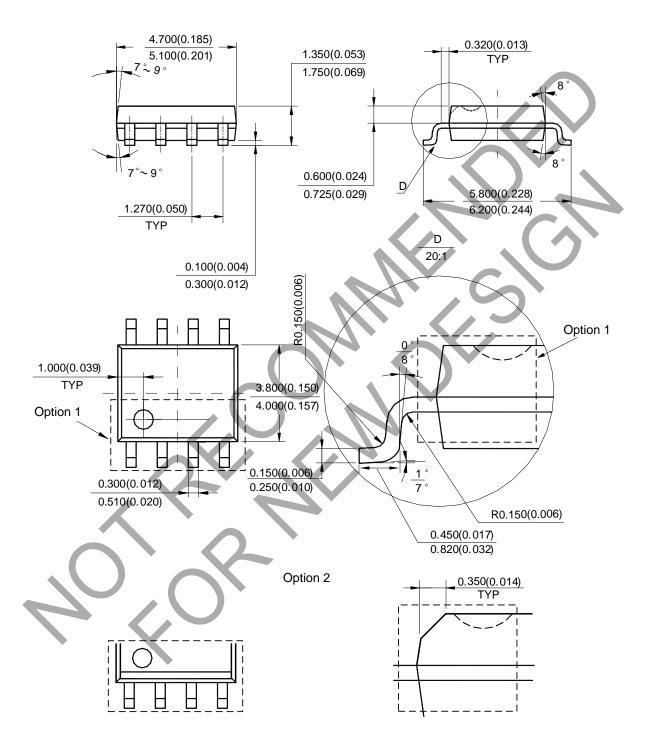
(Top View)

First and Second Lines: Logo and Marking ID Third Line: Date Code
Y: Year
WW: Work Week of Molding
A: Assembly House Code
XX: 7th and 8th Digits of Batch Number



Package Outline Dimensions (All dimensions in mm (inch).)

(1) Package Type: SO-8

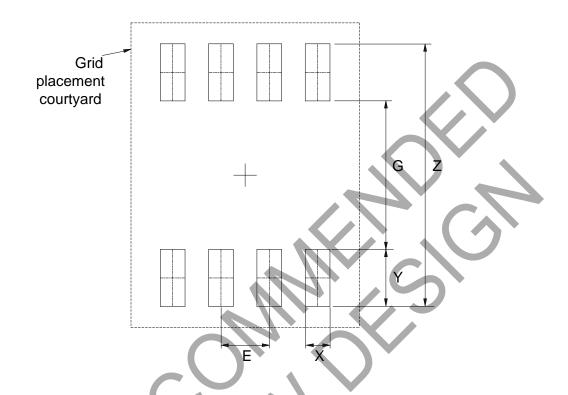


Note: Eject hole, oriented hole and mold mark is optional.



Suggested Pad Layout

(1) Package Type: SO-8



Dimensions	Z (mm)/(inch)	G X (mm)/(inch) (mm)/(inch)	Y (mm)/(inch)	E (mm)/(inch)
Value	6.900/0.272	3.900/0.154 0.650/0.026	1.500/0.059	1.270/0.050



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